

General Information

Series

Style

Description

Features

RoHS



KPS SMD Auto X8L HT150C

SMD, MLCC, Stacked, Single Chip, High Temperature, Automotive Grade

High Temperature, Automotive

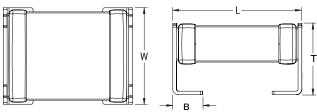
Stacked Chip

Grade

Yes







Click here for the 3D model.	——————————————————————————————————————		Termination	Tin
			Qualifications	AEC-Q200
			AEC-Q200	Yes
			Typical Component Weight	160 mg
		Chip Size	1210-1	
		Shelf Life	78 Weeks	
		MSL	1	
Dimensions			Specifications	
L	3.5mm +/-0.3mm		Capacitance	2.2 uF
W	2.6mm +/-0.3mm		Measurement Condition	1 kHz 1.0Vrms

3.35mm +/-0.10mm

0.8mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	600

Т

В

MSL	1			
Specifications				
Capacitance	2.2 uF			
Measurement Condition	1 kHz 1.0Vrms			
Tolerance	10%			
Voltage DC	25 VDC			
Dielectric Withstanding Voltage	62.5 VDC			
Temperature Range	-55/+150°C			
Temp. Coefficient	X8L			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	+15% (-55C to +125C), +15/-40% (125C to 150C), 1kHz 1.0Vrms			
Dissipation Factor	2.5%1kHz1.0Vrms			
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours			
Insulation Resistance	227.3 MOhms			

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